

STX13005

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- n HIGH VOLTAGE CAPABILITY
- n LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- n VERY HIGH SWITCHING SPEED

APPLICATION

- n COMPACT FLUORESCENT LAMPS (CFLS)
- SWITCH MODE POWER SUPPLIES (AC / DC CONVERTERS)



The device is manufactured using high voltage Multi-Epitaxial Planar technology for high switching speeds and high voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.

Figure 1: Package

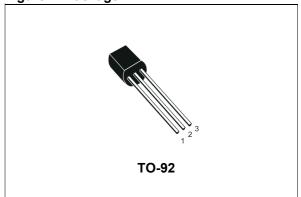


Figure 2: Internal Schematic Diagram

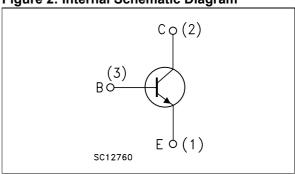


Table 1: Order Code

Part Number	Marking	Package	Packaging	
STX13005	X13005	TO-92	Bulk	
STX13005-AP	X13005	TO-92 AP	Ammopack	

Table 2: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{BE} = 0)	700	V
V_{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V
V _{EBO}	Emitter-Base Voltage (I_C = 0, I_B = 1.5 A, t_p < 10ms)	V _{(BR)EBO}	V
I _C	Collector Current	3	Α
I _{CM}	Collector Peak Current (t _p < 5ms)	6	Α
Ι _Β	Base Current	1.5	Α
I _{BM}	Base Peak Current (t _p < 5ms)	3	Α
P _{tot}	Total Dissipation at T _C = 25 °C	2.8	W

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Symbol	Parameter	Value	Unit
T _{stg}	Storage Temperature	-65 to 150	°C
T _J	Max. Operating Junction Temperature	150	°C

Table 3: Thermal Data

Symbol	Parameter			Unit
R _{thj-case}	Thermal Resistance Junction-Case	Max	44.6	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient	Max	150	°C/W

Table 4: Electrical Characteristics (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Cor	nditions	Min.	Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current	V _{CE} = 700 V				1	mA
	(V _{BE} = 0)	V _{CE} = 700 V	T _j = 125 °C			5	mA
I _{CEO}	Collector Cut-off Current	V _{CE} = 400 V				1	mA
	$(I_B = 0)$						
V _{(BR)EBO}	Emitter-Base	I _E = 10 mA	L = 25 mH	9		18	V
	Breakdown Voltage						
	$(I_C = 0)$						
V _{CE(sus)} *	Collector-Emitter	I _C = 10 mA		400			V
	Sustaining Voltage						
	$(I_B = 0)$						
V _{CE(sat)} *	Collector-Emitter	I _C = 1 A	I _B = 200 mA			0.5	V
	Saturation Voltage	I _C = 2 A	$I_B = 500 \text{ mA}$			0.6	V
		I _C = 3 A	I _B = 750 mA			5	V
V _{BE(sat)} *	Base-Emitter	I _C = 1 A	I _B = 200 mA			1.2	V
	Saturation Voltage	I _C = 2 A	I _B = 500 mA			1.6	V
h _{FE} *	DC Current Gain	I _C = 1 A	V _{CE} = 5 V	10		30	
		I _C = 2 A	$V_{CE} = 5 V$	8		24	
	RESISTIVE LOAD	I _C = 2 A	V _{CC} = 125 V				
t_s	Storage Time	I _{B1} = - I _{B2} = 400 mA	t _p = 30 μs		1.65		μs
t _f	Fall Time	(see figure 16)	,		260		ns
	INDUCTIVE LOAD	I _C = 1 A	V _{Clamp} = 300 V				
t_s	Storage Time	I _{B1} = 200 mA	$V_{BE(off)} = -5 V$		8.0		μs
t_f	Fall Time	L = 50 mH	$R_{BB} = 0$		150		ns
		(see figure 15)					

^{*} Pulsed: Pulsed duration = 300 μ s, duty cycle \leq 1.5 %.

Figure 3: Safe Operating Area

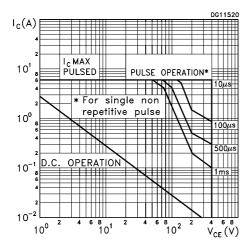


Figure 4: Output Chatacterisctics

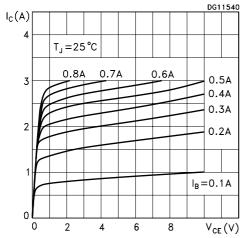


Figure 5: DC Current Gain

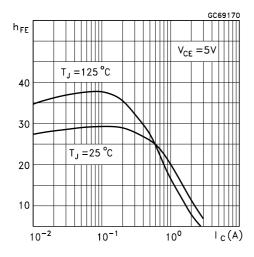


Figure 6: Derating Curve

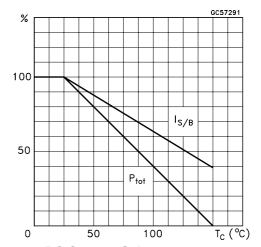


Figure 7: DC Current Gain

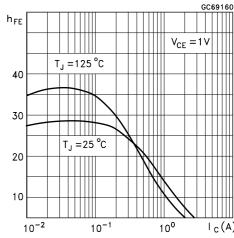


Figure 8: Collector-Emitter Saturation Voltage

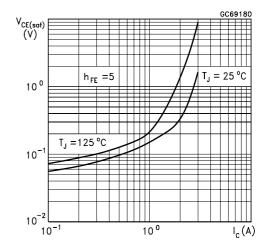


Figure 9: Base-Emitter Saturation Voltage

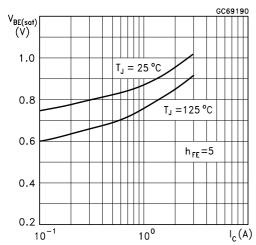


Figure 10: Resistive Load Fall Time

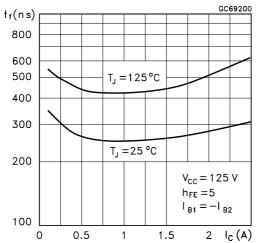


Figure 11: Inductive Load Fall Time

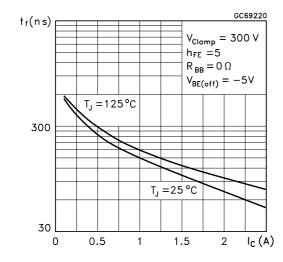


Figure 12: Resistive Load Storage Time

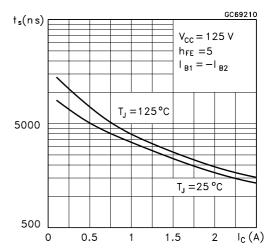


Figure 13: Inductive Load Storage Time

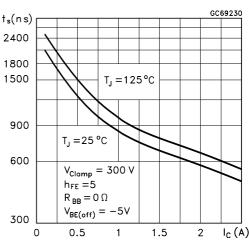


Figure 14: Reverse Biased Safe Operating Area

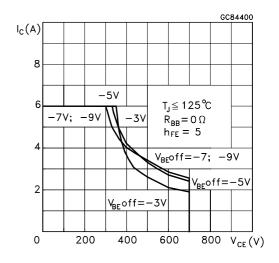


Figure 15: Inductive Load Switching Test Circuit

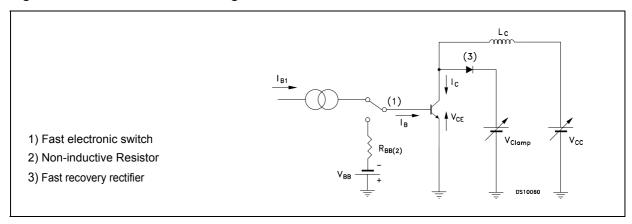
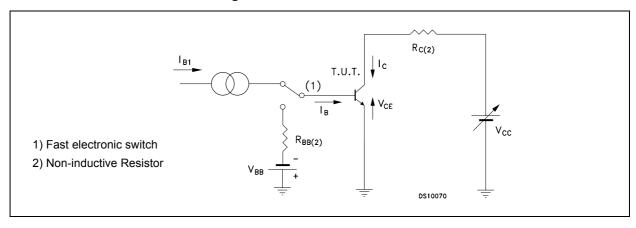
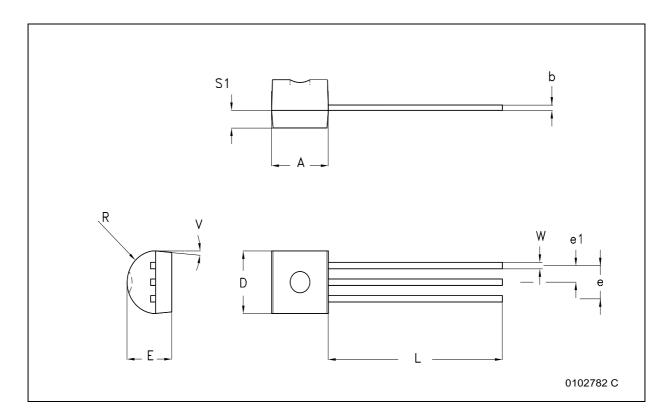


Table 16: Restistive Load Switching Test Circuit



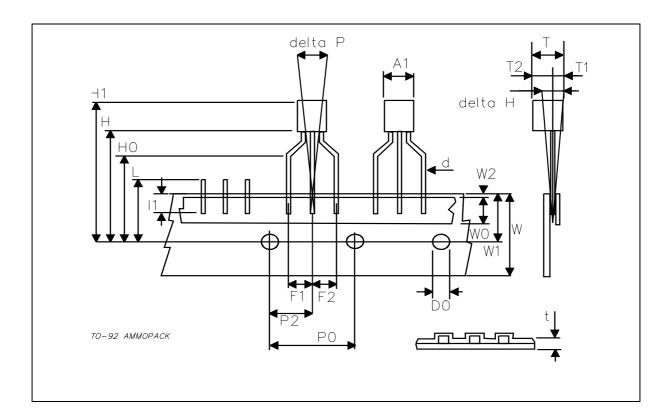
TO-92 BULK SHIPMENT MECHANICAL DATA

DIM.	mm.					
Dilvi.	MIN.	TYP	MAX.			
А	4.32		4.95			
b	0.36		0.51			
D	4.45		4.95			
E	3.30		3.94			
е	2.41		2.67			
e1	1.14		1.40			
L	12.70		15.49			
R	2.16		2.41			
S1	0.92		1.52			
W	0.41		0.56			
V		5 ^O				



TO-92 AMMOPACK SHIPMENT (Suffix"-AP") MECHANICAL DATA

DIM.	mm.			
	MIN.	TYP	MAX.	
A1			4.80	
Т			3.80	
T1			1.60	
T2			2.30	
d			0.48	
P0	12.50	12.70	12.90	
P2	5.65	6.35	7.05	
F1,F2	2.44	2.54	2.94	
delta H	-2.00		2.00	
W	17.50	18.00	19.00	
W0	5.70	6.00	6.30	
W1	8.50	9.00	9.25	
W2			0.50	
Н	18.50		20.50	
H0	15.50	16.00	16.50	
H1			25.00	
D0	3.80	4.00	4.20	
t			0.90	
L			11.00	
I1	3.00			
delta P	-1.00		1.00	



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Table 5: Revision History

Date	Release	Change Designator
01-Jul-2004	1	First Release.
11-Feb-2005	2	New table on page 1.

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